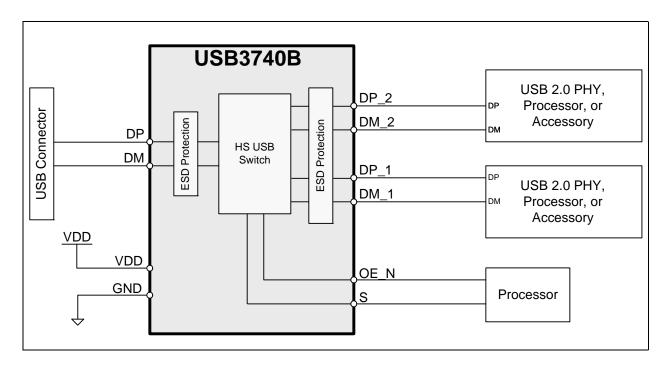


## High Speed USB 2.0 Switch with ESD Protection and Low Standby Current

#### Features

- High Speed USB Mux for multiplexing the USB lanes between different functions
  - Switch the USB connector between two different functions
  - Up to 1GHz Bandwidth
- USB Port ESD Protection (**DP/DM**)
  - 8kV HBM

- flexPWR<sup>TM</sup> Technology
  - 30nA Active/Standby Current
  - Extremely low power design ideal for battery powered applications
- Control inputs accommodate 1.8V to 5V inputs
- DP/DM tolerate up to 5.5V
- -40°C to +85°C Operating Temperature
- 10-pin, QFN, RoHS compliant package; (1.3mm x 1.8mm x 0.55mm height, 0.4mm pitch)
- 10-pin, QFN, RoHS compliant package; (1.6mm x 2.1mm x 0.55mm height, 0.5mm pitch)
- Automotive option



#### **Block Diagram**

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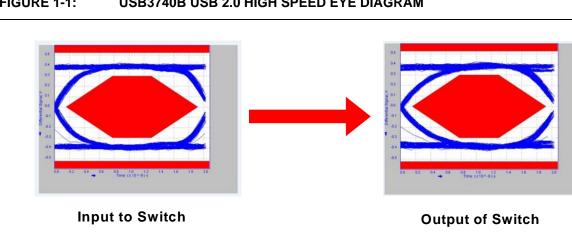
#### **Table of Contents**

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#### 1.0 GENERAL DESCRIPTION

The USB3740B is a USB 2.0 compliant High Speed switch that provides robust ESD protection to the interface in an extremely small package. Outstanding ESD robustness eliminates the need for external ESD protection devices to save eBOM cost and PCB area.

The high bandwidth capabilities of the USB3740B enable extremely low high frequency loss and an exceptionally clean USB 2.0 High Speed eye diagram.



#### FIGURE 1-1: **USB3740B USB 2.0 HIGH SPEED EYE DIAGRAM**

#### 1.1 **Reference Document**

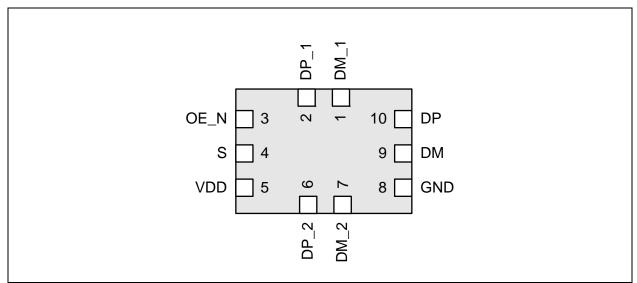
Universal Serial Bus Specification, Revision 2.0

### 2.0 PIN LAYOUT

#### 2.1 Pin Diagram

The USB3740B is available in both a 0.4mm pitch QFN (1.3mm x 1.8mm x 0.55mm height) and 0.5mm pitch QFN (1.6mm x 2.1mm x 0.55mm height) package. The 0.5mm pitch package can be ordered in standard or automotive configurations. For additional ordering information, refer to the Product Identification System section.

FIGURE 2-1: USB3740B PACKAGE DIAGRAM



#### 2.2 Ball/Pin Definitions

The following table details the ball/pin definitions for the package diagram above.

Pin	Name	Type/ Direction	Description			
10	DP	Analog	USB Mux Output			
9	DM	Analog				
2	2 DP_1 Analog		USB Mux Input 1			
1	DM_1	Analog				
6	6 DP_2 Analog		USB Mux Input 2			
7	DM_2	Analog				
8	GND	Analog	Ground			
5	VDD	Analog	Power			
4	S	Digital Input	Switch control. Refer to Table 4-1.			
3	OE_N	Digital Input	Active low switch Output Enable. Refer to Table 4-1.			

### 3.0 ELECTRICAL SPECIFICATIONS

#### 3.1 Absolute Maximum Ratings

#### TABLE 3-1: ABSOLUTE MAXIMUM RATINGS

Description			Rating	Unit
VDD Voltage to GND			5.0	V
Any other pin to GND			/DD+0.5	V
Operating Temperature Range	Operating Temperature Range			С
Storage Temperature Range			150	С
ESD Rating HBM				V

Stresses beyond the Absolute Maximum Ratings may damage the USB3740B.

#### 3.2 Electrical Specifications

#### TABLE 3-2: ELECTRICAL SPECIFICATIONS

Characteristic	Symbol	MIN	TYP	MAX	Units	Conditions	
$V_{DD}$ = 5.0V, $T_A$ = -40C to 85C, all typical values at $T_A$ = 25C unless otherwise noted.							
VDD Recommended Operating	g Conditions						
Input Voltage	V <sub>DD</sub>	3.0		5.5	V		
Active/Standby	I <sub>DD</sub>		30	175	nA		
USB Mux Characteristics					•		
USB Mux On Resistance	R <sub>ON_USB</sub>	1	2	5	ohm	0V < Vin < 3.3V	
		1	2	2.5		0V < Vin < 0.4V	
USB Mux Off Leakage	I <sub>OFF_USB</sub>		100	200	nA	0V < Vin < 3.3V	
On Capacitance	C <sub>ON_USB</sub>		5	7	pF	$V_{DD} = 3V$	
Off Capacitance	C <sub>OFF_USB</sub>		3	4	pF	$V_{DD} = 3V$	
Off Isolation		-30	-32	-40	dB	$R_L = 50$ ohm, $F = 250MHz$	
Crosstalk		-30	-45	-60	dB	$R_{L} = 50 \text{ ohm}, F = 250 \text{MHz}$	
Bandwidth (-3dB)	BW	950	1000	1100	MHz	$R_L = 50$ ohm, $C_L = 0pF$	
		850	950	980		$R_L = 50$ ohm, $C_L = 5pF$	
		530	560	600		$R_L = 50$ ohm, $C_L = 10pF$	
Control Signal Characteristics							
Input Logic High Threshold	V <sub>IN_H</sub>	1.4			V		
Input Logic Low Threshold	V <sub>IN_L</sub>			0.4	V		

#### 4.0 GENERAL OPERATION

The USB3740B is a high bandwidth switch suitable for many applications, including High Speed USB. The mux allows high speed signals to pass through and still meet HS USB signaling requirements.

The USB3740B will protect the system from ESD stress events on all **DP** and **DM** pins. The USB3740B provides ESD protection to the IEC-61000 ESD specification.

The USB mux is designed to pass High Speed USB signals to the USB connector, and allows for two USB inputs to be multiplexed into one USB output.

The USB Mux is designed to pass USB signals from 0 to **VDD**. It is not designed to pass signals that go above **VDD** or below ground.

The USB3740B switches are controlled by the digital signals OE\_N and S, as shown in Table 4-1.

OE_N	S	Switch State
1	Х	STANDBY: • Both switch paths disconnected. • Lowest power state
0	0	DP = DP1, DM = DM1:
0	1	DP = DP2, $DM = DM2$ :

TABLE 4-1:USB3740B SWITCH STATES DEFINITION

### 5.0 APPLICATION NOTES

#### 5.1 ESD Performance

The USB3740B is protected from ESD strikes. By eliminating the requirement for external ESD protection devices, board space is conserved, and the board manufacturer is enabled to reduce cost. The advanced ESD structures integrated into the USB3740B protect the device whether or not it is powered up.

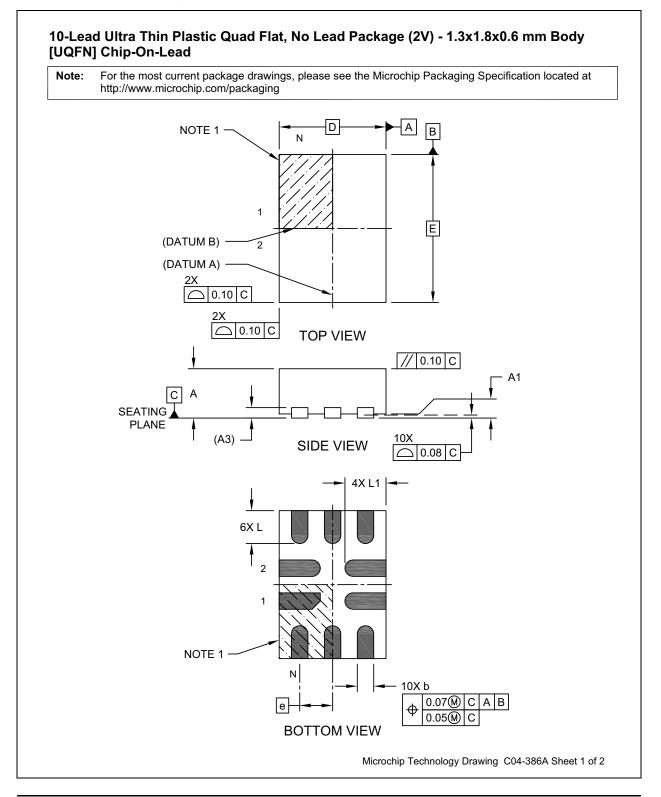
#### 5.1.1 HUMAN BODY MODEL (HBM) PERFORMANCE

HBM testing verifies the ability to withstand the ESD strikes like those that occur during handling and manufacturing, and is done without power applied to the IC. To pass the test, the device must have no change in operation or performance due to the event. The USB3740B HBM performance is detailed in Table 3-1.

### 6.0 PACKAGE OUTLINES

#### 6.1 1.3mm x 1.8mm QFN

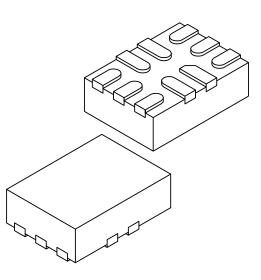
FIGURE 6-1: 10-PIN, 1.3MM X 1.8MM QFN PACKAGE OUTLINE



#### FIGURE 6-2: 10-PIN, 1.3MM X 1.8MM QFN PACKAGE DIMENSIONS

## 10-Lead Ultra Thin Plastic Quad Flat, No Lead Package (2V) - 1.3x1.8x0.6 mm Body [UQFN] Chip-On-Lead

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units	Ν	S	
Dimensior	n Limits	MIN	NOM	MAX
Number of Terminals	Ν		10	
Pitch	е		0.40 BSC	
Overall Height	Α	0.50 0.55 0.60		
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	A3		0.127 REF	
Overall Length	D		1.30 BSC	
Overall Width	E	1.80 BSC		
Terminal Width	b	0.15 0.20 0.25		
Terminal Length	L	0.35	0.40	0.45
Terminal Length	L1	0.45	0.50	0.55

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

- 2. Package is saw singulated
- 3. Dimensioning and tolerancing per ASME Y14.5M

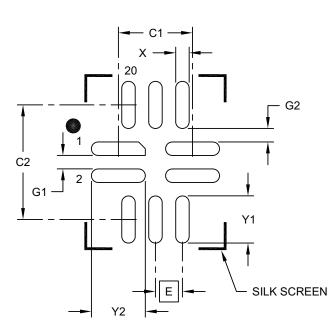
BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-386A Sheet 2 of 2

#### FIGURE 6-3: 10-PIN, 1.3MM X 1.8MM QFN PACKAGE LAND PATTERN

## 10-Lead Ultra Thin Plastic Quad Flat, No Lead Package (2V) - 1.3x1.8x0.6 mm Body [UQFN] Chip-On-Lead

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	Limits	MIN	NOM	MAX
Contact Pitch	E	0.40 BSC		
Contact Pad Spacing	C1		1.10	
Contact Pad Spacing	C2		1.70	
Contact Pad Width (X10)	Х			0.20
Contact Pad Length (X6)	Y1			0.70
Contact Pad Length (X4)	Y2			0.80
Contact Pad to Pad (X6)	G1	0.20		
Contact Pad to Pad (X4)	G2	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

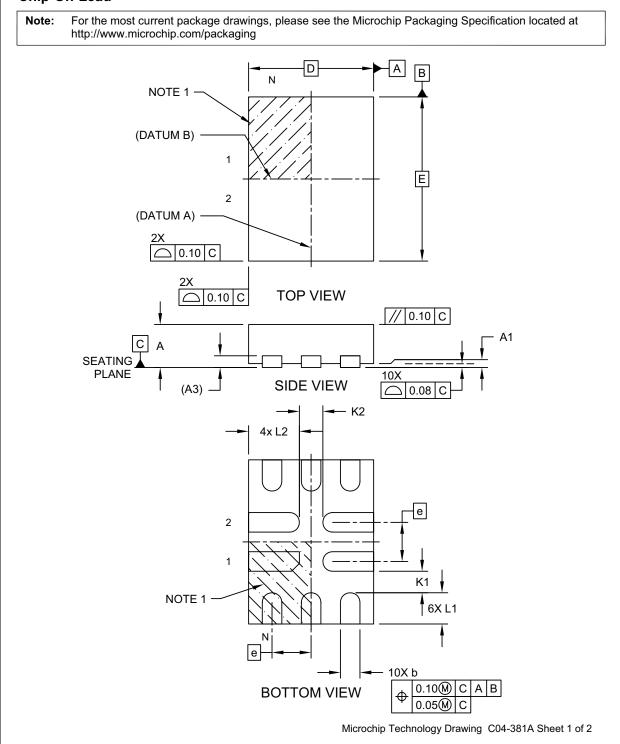
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2386A

#### 6.2 1.6mm x 2.1mm QFN

#### FIGURE 6-4: 10-PIN, 1.6MM X 2.1MM QFN PACKAGE OUTLINE

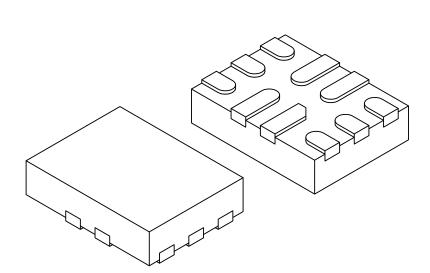
## 10-Lead Ultra Thin Plastic Quad Flat, No Lead Package (3V) - 1.6.x2.1 mm Body [UQFN Chip-On-Lead



#### FIGURE 6-5: 10-PIN, 1.6MM X 2.1MM QFN PACKAGE DIMENSIONS

## 10-Lead Ultra Thin Plastic Quad Flat, No Lead Package (3V) - 1.6x2.1 mm Body [UQFN] Chip-On-Lead

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			S
Dimension	Limits	MIN	NOM	MAX
Number of Terminals	N		10	
Pitch	е		0.50 BSC	
Overall Height	Α	0.50	0.55	0.60
Standoff	A1	0.00	0.02	0.05
Terminal Thickness	(A3)	0.127 REF		
Overall Width	E	2.10 BSC		
Overall Length	D		1.60 BSC	
Terminal Width	b	0.20 0.25 0.3		0.30
Terminal Length	L1	0.35	0.40	0.45
Terminal Length	L2	0.60 0.65 0.70		0.70
Terminal Clearance	K1	0.20		
Terminal Clearance	K2	0.20	-	-

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Package is saw singulated

3. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

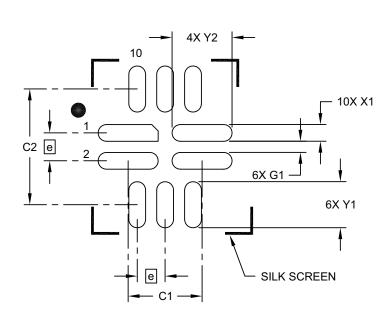
REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-379A Sheet 2 of 2

#### FIGURE 6-6: 10-PIN, 1.6MM X 2.1MM QFN PACKAGE LAND PATTERN

## 10-Lead Ultra Thin Plastic Quad Flat, No Lead Package (3V) - 1.6.x2.1 mm Body [UQFN Chip-On-Lead

**Note:** For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



#### RECOMMENDED LAND PATTERN

	Ν	/ILLIMETER	S		
Dimensior	Limits	MIN	NOM	MAX	
Contact Pitch	ntact Pitch E		0.50 BSC		
Contact Pad Spacing	C1		1.325		
Contact Pad Spacing	Contact Pad Spacing C2		2.075		
Contact Pad Width (X10)	X1			0.30	
Contact Pad Length (X6)	Y1			0.825	
Contact Pad Length (X4)	Y2			1.075	
Contact Pad to Center Pad (X6)	G1	0.20			

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing C04-2381A

### APPENDIX A: DATA SHEET REVISION HISTORY

#### TABLE A-1: REVISION HISTORY

Revision	Section/Figure/Entry	Correction		
DS00001725D (03-11-15)	Section 6.0, "Package Outlines," on page 9	Updated 1.6x2.1 UQFN and 1.3x1.8 UQFN package drawings.		
DS00001725C (12-11-14)	Cover	Added bullet: "Automotive option (1.6 x 2.1mm, 0.5mm pitch package only)"		
		Added sub-bullet: "8kV HBM"		
	FIGURE 6-1: 10-pin, 1.3mm x 1.8mm QFN Package Outline on page 9 and FIGURE 6-4: 10-pin, 1.6mm x 2.1mm QFN Package Outline on page 12	Updated package drawings to latest revision C		
	Product Identification System	Added automotive ordering code information. Added tape and reel quantity information.		
	Section 2.1, "Pin Diagram," on page 5	Clarified which package is available for the automotive option.		
	All: Cover, Order Codes	Made operating temperature references generic "-40°C to +85°C"		
DS00001725B (08-21-14)	Document is converted to Mic replaces Ordering Information	rochip template; Product Identification System page		
DS00001725A replaces the previous SMSC version, Rev. 1.2		Title changed from "High Speed Switch for Mobile and Portable Applications" to "High Speed USB 2.0 Switch with ESD Protection and Low Standby Current"		
Rev. 1.2 (07-30-12)	Table 3-1, "Absolute Maximum Ratings," on page 6	Corrected "Any other pin to GND" row's rating to "- 0.3 to VDD+0.5V"		
Rev. 1.1 (12-15-11)	Section 2.2, "Ball/Pin Definitions"	In Section 2.2, changed the description of Pin #8 as follows: "Ground"		
Rev. 1.0 (08-03-11)	Data Sheet Release			

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PART NO.	- <u>xxx</u>	- <u>[X]</u> <sup>(1)</sup>	Exa	ampl	es:
Device	Package	Tape and Reel Option	 a) b)	10-  (1.3 Tap	B3740B-Al2-TR pin QFN RoHS Compliant package 3 x 1.8 x 0.55mm, 0.4mm pitch) e & Reel B3740B-Al9-TR
Device:	USB3740B		5)	10-j (1.6	in QFN RoHS Compliant package 5 x 2.1 x 0.55mm, 0.5mm pitch) e & Reel
Package:		N (1.3 x 1.8 x 0.55mm, 0.4mm pitch) N (1.6 x 2.1 x 0.55mm, 0.5mm pitch)			
Tape and Reel Option:	Blank = Tray packa TR = Tape and f		Not	e 1:	Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option. Reel size is 3,000.

#### Automotive Ordering Code

	<u>X<sup>(2)</sup> - X / XX - XXX</u> Tape Temp. Package Automotive and Code Reel	Example: a) USB3740T-I/ML-V01 Tape & Reel 10-pin QFN RoHS Compliant package (1.6mm x 2.1mm, 0.5mm pitch), Automotive
Device:	USB3740	Autonouve
Tape and Reel:	T = Tape and Reel	
Temperature:	$I = -40^{\circ}C \text{ to } +85^{\circ}C$	Note 2: Tape and Reel identifier only appears in the catalog part number description. This identifier is used for ordering purposes and is
Package:	ML = 10-pin QFN (1.6mm x 2.1mm, 0.5mm pitch)	not printed on the device package. Check with your Microchip Sales Office for package availability with the Tape and Reel option.
Automotive Code:	V01 = Automotive	Reel size is 3,000.

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